

Dual P-Channel MOSFET

General Description

The WSP4099 is the highest performance trench P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4099 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

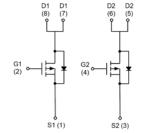
BVDSS	RDSON	ID
-40V	30mΩ	-6.5A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOP-8 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-40	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, -V _{GS} @ -10V ¹	-6.5	А
I _D @T _C =100℃	Continuous Drain Current, -V _{GS} @ -10V ¹	-4.5	А
I _{DM}	Pulsed Drain Current ²	-22	А
EAS	Single Pulse Avalanche Energy ³	25	mJ
I _{AS}	Avalanche Current	-10	А
P _D @T _C =25℃	Total Power Dissipation ⁴	2.0	W
T _{STG}	Storage Temperature Range -55 to ⁻		°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eja}	Thermal Resistance Junction-Ambient ¹		110	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		50	°C/W



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-40			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=-1mA		-0.02		V/℃
Baaraa	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-6.5A		30	38	mΩ
R _{DS(ON)}		V _{GS} =-4.5V , I _D =-4.5A		46	62	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} . In =-250uA	-1.5	-2.0	-2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID2300A		3.72		V/℃
	Drain Source Lookage Current	$V_{\text{DS}}\text{=-32V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			1	
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-32V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}55^\circ\!\mathrm{C}$			5	– uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-4A		8		S
Qg	Total Gate Charge (-4.5V)			7.5		
Q _{gs}	Gate-Source Charge	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-6.5A		2.4		nC
Q _{gd}	Gate-Drain Charge			3.5		
T _{d(on)}	Turn-On Delay Time			8.7		
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =6 Ω ,		7		20
T _{d(off)}	Turn-Off Delay Time	I _D =-1A ,RL=20Ω		31		ns
T _f	Fall Time			17		
Ciss	Input Capacitance			668		
C _{oss}	Output Capacitance	V_{DS} =-15V , V_{GS} =0V , f=1MHz		98		pF
C _{rss}	Reverse Transfer Capacitance			72		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	V _{DD} =-25V , L=0.5mH , I _{AS} =-10A	20			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	$V_G = V_D = 0V$, Force Current			-2	А
I _{SM}	Pulsed Source Current ^{2,6}				-22	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , TJ=25℃			-1.0	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3. The EAS data shows Max. rating . The test condition is VDD=-25V,VGS=-10V,L=0.5mH,IAS=-10A

4. The power dissipation is limited by 150 °C junction temperature

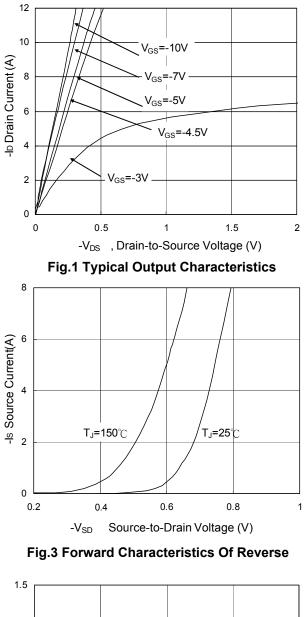
5. The Min. value is 100% EAS tested guarantee.

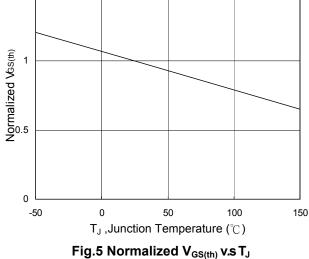
6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.

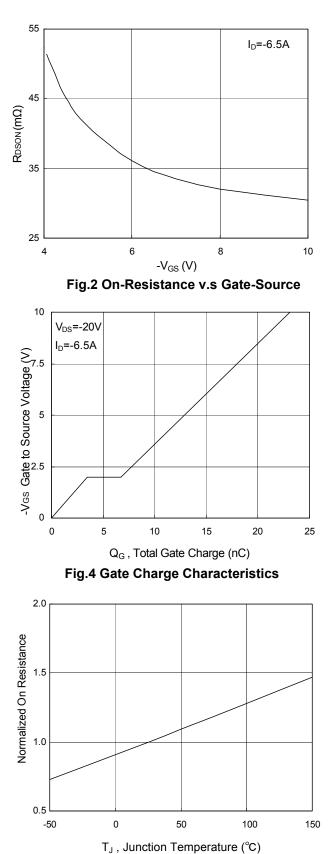


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Typical Characteristics

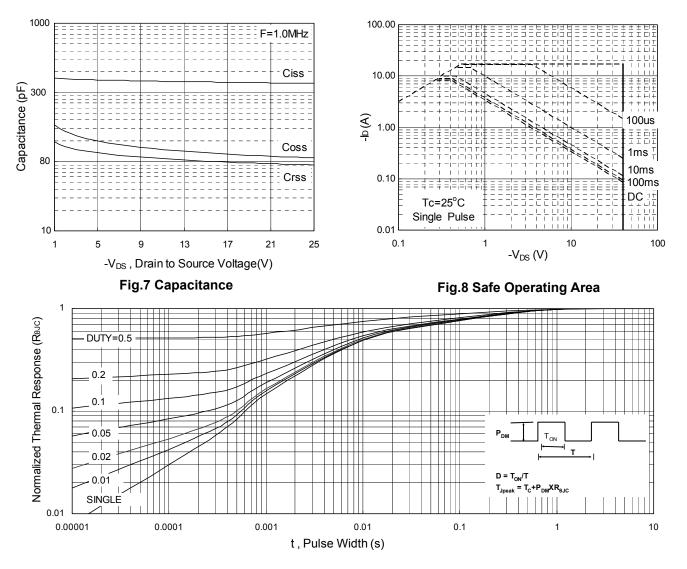




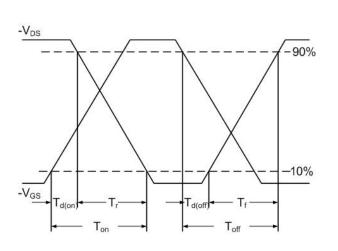


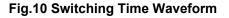


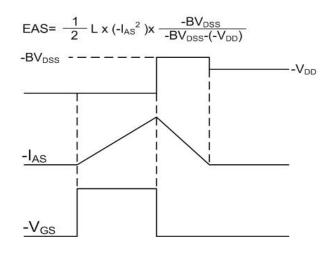
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